Initial Review

BOX AE

Docket No. 0756-935

KSPaus

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

	ALL RA	%		
1	Vivin	In re PATENT application of:	)	
	JUN 25	Shunpei YAMAZAKI et al.	)	Ex. Wilczewski
3	1996	Sepal No. 08/160,909	)	Art Unit No. 1107
10	Filed: December 3, 1993			
		For: METHOD OF FABRICATING	)	
		SEMICONDUCTOR DEVICES AND	)	
		APPARATUS FOR PROCESSING	)	
		A SEMICONDUCTOR	)	

## PETITION TO ACCEPT INFORMATION DISCLOSURE STATEMENT AFTER FINAL REJECTION

RECEIVED

Honorable Assistant Commissioner for Patents

JUL - 3 1996

Washington, D.C. 20231

**GROUP 1100** 

Sir:

The Information disclosure Statement transmitted herewith is being filed after a final action under §1.113, but before the payment of the issue fee.

No item of information in the attached Information Disclosure Statement was cited in a communication from a patent office outside the U.S. in a counterpart foreign application, or to the knowledge of the person whose signature appears below after making reasonable inquiry, was known more than three months prior to the filing date<sub>SI</sub>of<sub>6</sub> said, Information Disclosure Statement to any individual having 1 122 duty to 130 close such information to the U.S. Patent and Trademark Office.

Applicant hereby petitions for the consideration of the accompanying Information Disclosure Statement in accordance with 37 CFR 1.97(d)(ii).

Applicant submits herewith the petition fee of \$130 as set forth in \$1.17(i).

Respectfully submitted,

Jeffrey L. Costellia Reg. No. 35,483

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